

**Microchip****Filter specification****TFS140BZ****1/5****Measurement condition**

Ambient temperature $T_A$ :	23	°C
Input power level:	0	dBm
Terminating impedance: *)		
Input:	72 $\Omega$	-32 pF
Output:	93 $\Omega$	-26 pF

**Characteristics**

## Remark:

The reference level for the relative attenuation  $a_{rel}$  of the TFS140BZ is the minimum of the pass band attenuation. This value is defined as the insertion loss  $a_e$ . The nominal frequency  $f_N$  is fixed at 140 MHz without any tolerance. The values of relative attenuation  $a_{rel}$  are guaranteed over the whole operating temperature range. The frequency shift of the filter within the operating temperature range is included in the production tolerance scheme.

<b>D a t a</b>	<b>typ. value</b>		<b>tolerance / limit</b>	
<b>Insertion loss</b> (reference level)	$a_e$	13 dB	max.	15 dB
<b>Nominal frequency</b>	$f_N$			140.0 MHz
<b>Passband</b>	PB		$f_N \pm$	20 MHz
<b>Amplitude ripple within PB</b>	p-p	0.4 dB	max.	1 dB
<b>Bandwidth</b>	BW			
1 dB		51 MHz	min.	40 MHz
3 dB		53 MHz	min.	50 MHz
40 dB		65 MHz	max.	72 MHz
<b>Relative attenuation</b>	$a_{rel}$			
$f_N$	... $f_N \pm$ 20 MHz	0.4 dB	max.	1 dB
$f_N \pm$ 20 MHz	... $f_N \pm$ 25 MHz	0.6 dB	max.	3 dB
$f_N \pm$ 36 MHz	... $f_N \pm$ 55 MHz	44 dB	min.	40 dB
$f_N \pm$ 55 MHz	... $f_N \pm$ 100 MHz	51 dB	min.	45 dB
$f_N +$ 100 MHz	... $f_N +$ 160 MHz	46 dB	min.	40 dB
$f_N +$ 160 MHz	... $f_N +$ 190 MHz	51 dB	min.	45 dB
$f_N +$ 190 MHz	... $f_N +$ 290 MHz	40.8 dB	min.	40 dB
$f_N +$ 290 MHz	... $f_N +$ 1860 MHz	60 dB	min.	45 dB
<b>Group delay ripple within PB</b>	p-p	21 ns	max.	100 ns
<b>Return loss within PB</b>		5.4 dB	min.	4 dB
<b>Input power level</b>			max.	15 dBm
<b>Operating temperature range</b>	OTR			-40 °C ... +85 °C
<b>Storage temperature range</b>				-55 °C ... +125 °C
<b>Temperature coefficient of frequency</b>	$TC_f$ **)	-96 ppm/K		-

\*) The terminating impedances depend on parasitics and q-values of matching elements and the board used, and are to be understood as reference values only. Should there be additional questions do not hesitate to ask for an application note or contact our design team.

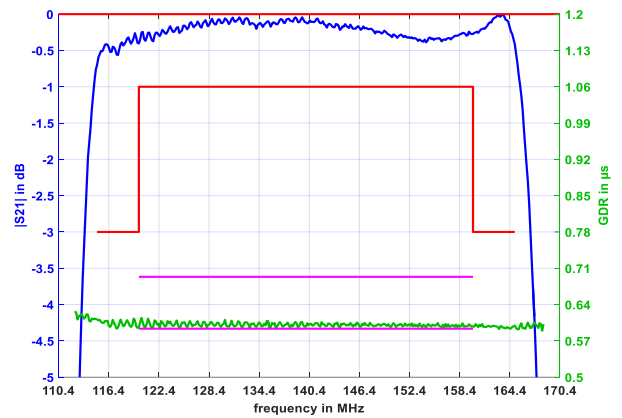
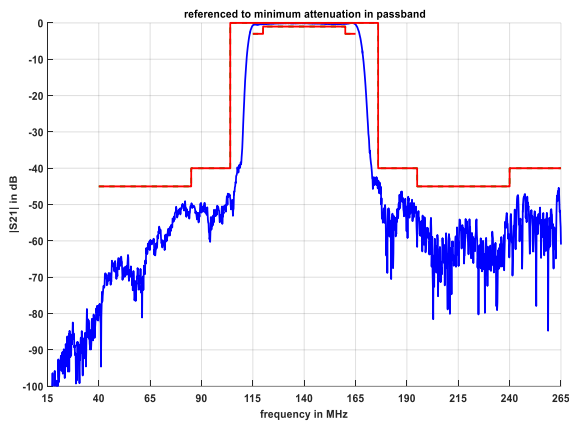
\*\*)  $\Delta f = TC_f(T - T_A)f_N$

**Generated:****Checked / Approved:**

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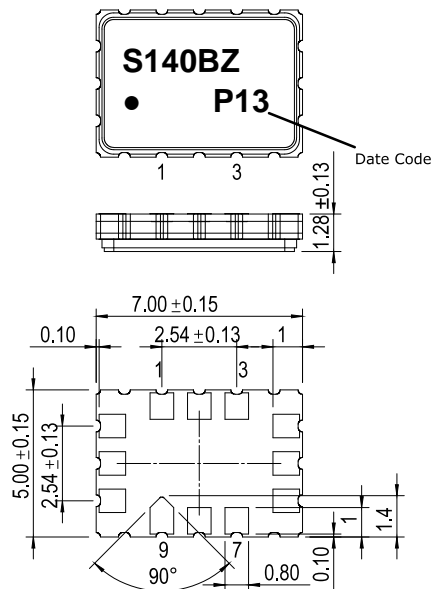
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Filter characteristic



Construction and pin connection

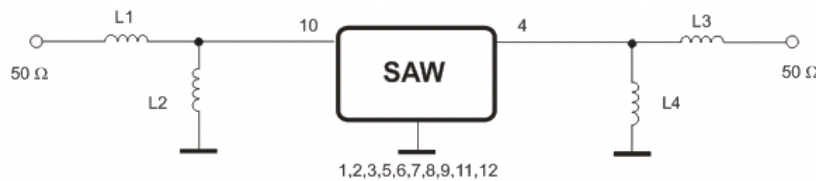
(All dimensions in mm)



- 1 Ground
- 2 Ground
- 3 Ground
- 4 Output
- 5 Ground
- 6 Ground
- 7 Ground
- 8 Ground
- 9 Ground
- 10 Input
- 11 Ground
- 12 Ground

Date code: Year + week  
 P 2022  
 R 2023  
 S 2024  
 ...

50 Ω Test circuit



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**Stability characteristics, reliability**

After the following tests the filter shall meet the whole specification:

1. Shock: 500 g, 1 ms, half sine wave, 3 shocks each plane;  
DIN IEC 60068 T2 - 27
2. Vibration: 10 Hz to 2000 Hz, 0.35 mm or 5 g respectively, 1 octave per min, 10 cycles per plane, 3 planes; DIN IEC 60068 T2 - 6
3. Change of temperature: -55 °C to 125 °C / 15 min. each / 100 cycles  
DIN IEC 60068 part 2 – 14 Test N
4. Resistance to solder heat (reflow): reflow possible: three times max.;  
for temperature conditions refer to the attached "Air reflow temperature conditions" on page 4;
5. SAW devices are Electrostatic Discharge (ESD) sensitive devices.

This filter is RoHS compliant (2011/65/EU+2015/863/EU)

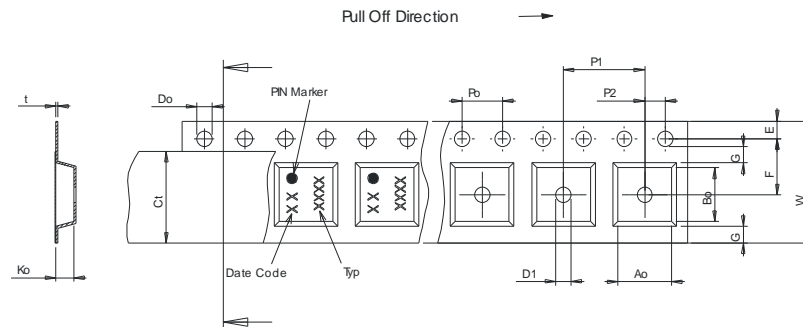
**Packing**

Tape & Reel: IEC 286 – 3, with exception of value for N and minimum bending radius;  
tape type II, embossed carrier tape with top cover tape on the upper side;

reel of empty components at start:	min. 300 mm
reel of empty components at start including leader:	min. 500 mm
trailer:	min. 300 mm

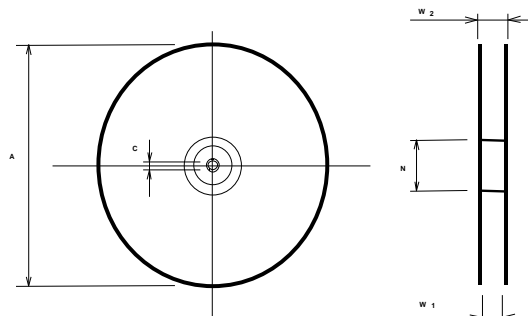
**Tape (all dimensions in mm)**

- W : 16.00 +0.3/-0.1
- Po : 4.00 ±0.1
- Do : 1.50 +0.1/-0
- E : 1.75 ±0.1
- F : 7.50 ±0.1
- G(min) : 0.75
- P2 : 2.00 ±0.1
- P1 : 8.00 ±0.1
- D1(min) : 1.50
- Ao : 5.40 ±0.1
- Bo : 7.60 ±0.1
- Ct : 13.30 ±0.1
- Ko : 2.00 ±0.1
- t : 0.30 ±0.05



**Reel (all dimensions in mm)**

- A : 330 or 180
- W1 : 16.4 +2/-0
- W2(max) : 22.40
- N(min) : 50.00
- C : 13.0 +0.5/-0.2



The minimum bending radius is 45 mm.

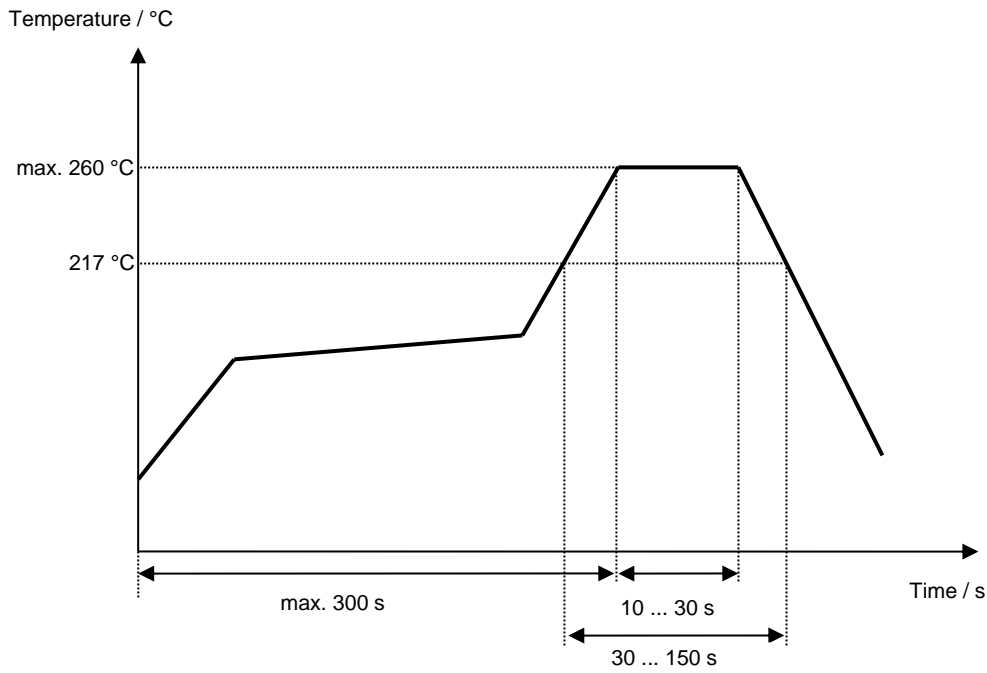
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**Air reflow temperature conditions**

<b>Conditions</b>	<b>Exposure</b>
Average ramp-up rate (30 °C to 217 °C)	less than 3 °C / second
> 100 °C	between 300 and 600 seconds
> 150 °C	between 240 and 500 seconds
> 217 °C	between 30 and 150 seconds
Peak temperature	max. 260 °C
Time within 5 °C of actual peak temperature	between 10 and 30 seconds
Cool-down rate (Peak to 50 °C)	less than 6 °C / second
Time from 30 °C to Peak temperature	no greater than 300 seconds

**Chip-mount air reflow profile**



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**Microchip****Filter specification****TFS140BZ****5/5****History**

<b>Version</b>	<b>Reason of Changes</b>	<b>Name</b>	<b>Date</b>
1.0	- Generation of development specification based on 140_rfq54 (sim1)	P. Jaster	21.04.2020
2.0	- Update to our preferred package (from BV27.1.B6-0 to BV101.1.A1-0). - Add the following additional far rejection limits: - $f_N+100\text{MHz} \dots f_N+190\text{MHz}$ 45dB min. - $f_N+190\text{MHz} \dots f_N+290\text{MHz}$ 40dB min. - $f_N+290\text{MHz} \dots f_N+1860\text{MHz}$ 45dB min.	Jaffer	29.06.2020
3.0	- Generation of filter specification - Change the following limits: - $f_N+100\text{MHz} \dots f_N+160\text{MHz}$ from 45dB to 40dB min - return loss within PB from min. 5dB to min. 4dB	Bonnen	27.10.2020
3.1	-Correct typos (add units to typ. values etc.)	Jaffer	24.11.2020
4.0	-Correct typos (correct labeling)	Bonnen	29.03.2022

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